



ON Semiconductor®

FDN360P

Single P-Channel, PowerTrench⁰ MOSFET

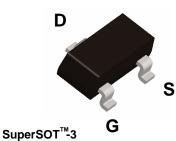
General Description

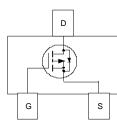
This P-Channel Logic Level MOSFET is produced using ON Semiconductor advanced Power Trench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

Features

- -2 A, -30 V. $R_{DS(ON)} = 80 \text{ m}\Omega @ V_{GS} = -10 \text{ V}$ $R_{DS(ON)} = 125 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$
- Low gate charge (6.2 nC typical)
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$.
- High power version of industry Standard SOT-23 package. Identical pin-out to SOT-23 with 30% higher power handling capability.
- These Devices are Pb-Free and are RoHS Compliant





8mm

Absolute Maximum Ratings T_A=25°C unless otherwise noted

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Symbol	Parameter		Ratings	Units		
V _{DSS}	Drain-Source Volta	ge		-30	V	
V _{GSS}	Gate-Source Volta	ge		±20	V	
ID	Drain Current – C	Continuous	(Note 1a)	-2	A	
	— F	Pulsed		-10		
P _D	Power Dissipation	for Single Operation	(Note 1a)	0.5	w	
			(Note 1b)	0.46	VV	
T _J , T _{STG}	Operating and Stor	Operating and Storage Junction Temperature Range		-55 to +150	°C	
Therma	I Characteris	tics				
R _{eJA}	Thermal Resistanc	e, Junction-to-Ambient	(Note 1a)	250	°C/W	
R _{0JC}	Thermal Resistanc	e, Junction-to-Case	(Note 1)	75	°C/W	
Packag	e Marking an	d Ordering Info	ormation			
Device	.		eel Size	Tape width	Quantity	

7"

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Publication Order Number: FDN360P /D

3000 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics		•		•	
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-30			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		-22		mV/°C
	Zero Gate Voltage Drain Current	$V_{\text{DS}} = -24 \text{V}, \qquad \text{V}_{\text{GS}} = 0 \text{ V}$			-1	μA
DSS	Zero Gale Vollage Drain Current	$V_{DS} = -24V, V_{GS} = 0 V, T_J = 55^{\circ}C$			-10	
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1	-1.9	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		4		mV/°C
R _{DS(on)}	Static Drain–Source	$V_{GS} = -10 \text{ V}, \qquad I_D = -2 \text{ A}$		63	80	mΩ
	On–Resistance			90 100	136 125	
I _{D(on)}	On–State Drain Current	$V_{GS} = -10 \text{ V}, \qquad V_{DS} = -5 \text{ V}$	-10			Α
g fs	Forward Transconductance	$V_{DS} = -5 \text{ V}, \qquad I_D = -2 \text{ A}$		5		S
Dynamic	c Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = -15 V$, $V_{GS} = 0 V$,		298		pF
Coss	Output Capacitance	f = 1.0 MHz		83		pF
C _{rss}	Reverse Transfer Capacitance			39		pF
Switchir	g Characteristics (Note 2)	-				
t _{d(on)}	Turn-On Delay Time	$V_{DD} = -15 V$, $I_D = -1 A$,		6	12	ns
tr	Turn–On Rise Time	$V_{GS} = -10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		13	23	ns
t _{d(off)}	Turn–Off Delay Time			11	20	ns
t _f	Turn–Off Fall Time			6	12	ns
Qg	Total Gate Charge	$V_{DS} = -15V$, $I_D = -3.6 A$,		6.2	9	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -10 V$		1		nC
Q _{gd}	Gate-Drain Charge	1		1.2		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings		•		
ls	Maximum Continuous Drain–Source				-0.42	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = -0.42 A$ (Note 2)		-0.8	-1.2	V

R_{8JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{8JC} is guaranteed by design while R_{8CA} is determined by the user's board design.

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a) 250°C/W when mounted on a 0.02 in² pad of 2 oz. copper.

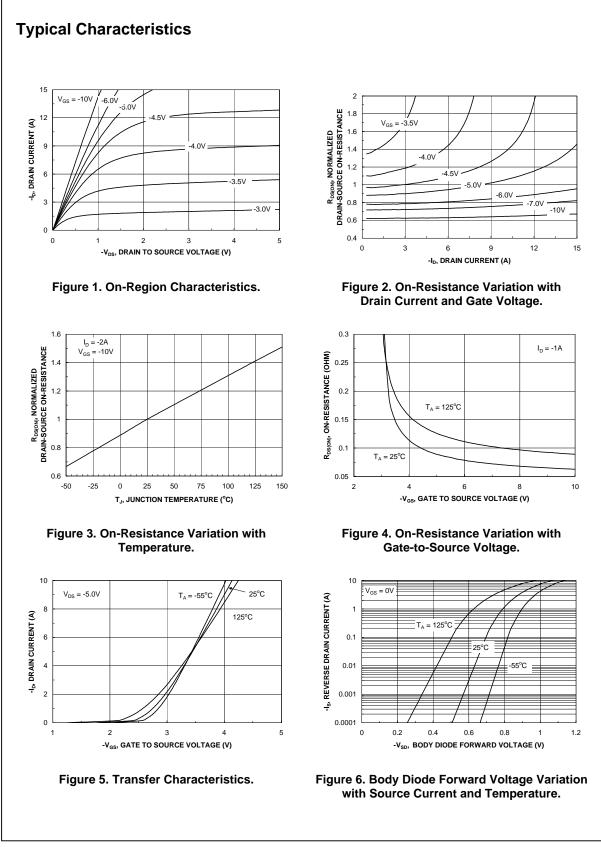


b) 270°C/W when mounted on a minimum pad.

Scale 1 : 1 on letter size paper

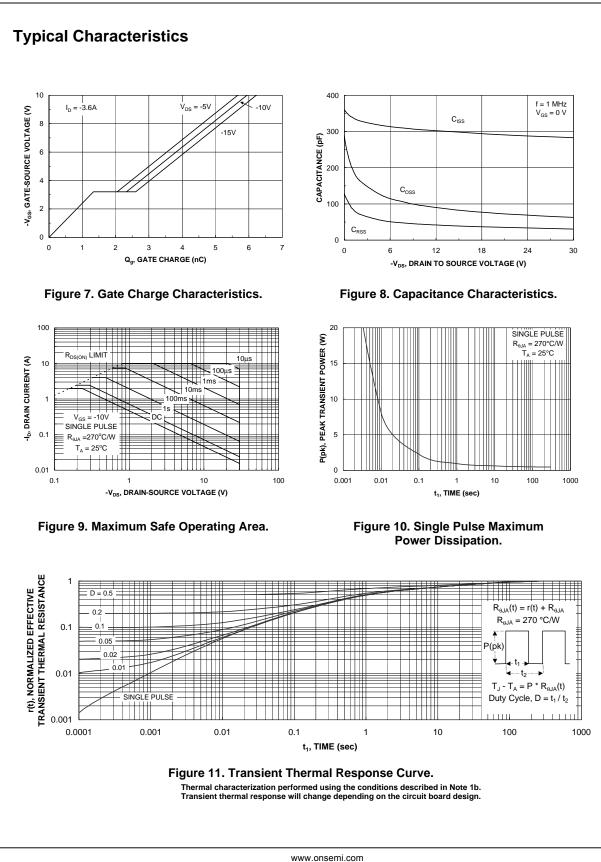
2. Pulse Test: Pulse Width $\leq 300~\mu s,~\text{Duty}~\text{Cycle} \leq 2.0\%$

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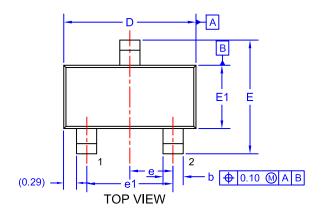
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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



SOT-23/SUPERSOT [™] -23, 3 LEAD, 1.4x2.9 CASE 527AG ISSUE A

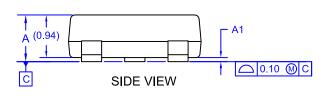
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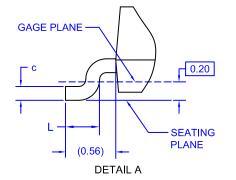


2.	ASME Y14.5M, 2009. ALL DIMENSIONS ARE IN MILLIMETERS. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.					
	DIM	MIN.	NOM.	MAX.		
	А	0.85	0.95	1.12		
	A1	0.00	0.05	0.10		
	b	0.370	0.435	0.508		
	с	0.085	0.150	0.180		
	D	2.80	2.92	3.04		
	Е	2.31	2.51	2.71		
	E1	1.20	1.40	1.52		
	е	0.95 BSC 1.90 BSC				
	e1					
	L	0.33	0.38	0.43		

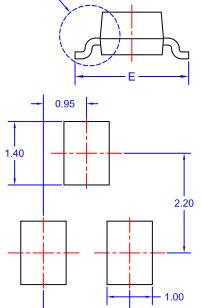
NOTES: UNLESS OTHERWISE SPECIFIED

1. DIMENSIONING AND TOLERANCING PER









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- 1.90

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "●", may or may not be present. Some products may not follow the Generic Marking.

•	(Note: Microdot may be in	either location) not follow the Generic Marking.	,
DOCUMENT NUMBER:	98AON34319E	Electronic versions are uncontrolled except when accessed directly from Printed versions are uncontrolled except when stamped "CONTROLLED	
DESCRIPTION:	SOT-23/SUPERSOT-23, 3	PAGE 1 OF 1	

XXX = Specific Device Code

= Pb-Free Package

= Month Code

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XXXM=

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